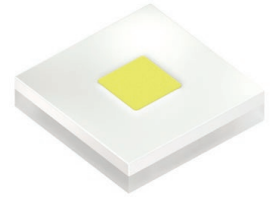


KW CSLNM1.TG

OSRAM OSTAR® Projection Compact

Compact light source with isolated heat sink for improved heat dissipation and high current chip technology for increased light output.



Applications

- Stage Lighting (LED & Laser)

Features:

- Package: white molded SMD ceramic package
- Chip technology: UX:3
- Typ. Radiation: 120° (Lambertian emitter)
- Color: Cx = 0.32, Cy = 0.33 acc. to CIE 1931 (● white)
- Corrosion Robustness Class: 3A
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)

Ordering Information

Type	Luminous Flux ¹⁾ $I_F = 1000 \text{ mA}$ Φ_V	Ordering Code
KW CSLNM1.TG-5N8N-ebvF46fcbB46-15B5	280 ... 450 lm	Q65113A1587

Maximum Ratings

Parameter	Symbol	Values
Operating Temperature	T_{op}	min. -40 °C max. 125 °C
Storage Temperature	T_{stg}	min. -40 °C max. 125 °C
Junction Temperature	T_j	max. 150 °C
Forward Current $T_s = 25 \text{ °C}$	I_F	min. 40 mA max. 3000 mA
Forward Current pulsed $D = 0.5; f = 120\text{Hz}; T_s = 25 \text{ °C}$	$I_{F \text{ pulse}}$	max. 3300 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	V_{ESD}	8 kV
Reverse current ²⁾	I_R	max. 200 mA

Characteristics

$I_F = 1000 \text{ mA}$; $T_S = 25 \text{ °C}$

Parameter	Symbol		Values
Partial Flux ³⁾ $I_F = 1000 \text{ mA}$	E_v	typ.	0.76
Chromaticity Coordinate ⁴⁾	C_x	typ.	0.32
	C_y	typ.	0.33
Viewing angle at 50% I_v	2ϕ	typ.	120 °
Radiating surface	A_{color}	typ.	1.03 x 1.03 mm ²
Forward Voltage ⁵⁾ $I_F = 1000 \text{ mA}$	V_F	min.	2.75 V
		typ.	3.00 V
		max.	3.50 V
Reverse voltage (ESD device)	V_{RESD}	min.	45 V
Reverse voltage ²⁾ $I_R = 20 \text{ mA}$	V_R	max.	1.2 V
Real thermal resistance junction/solderpoint ⁴⁾	$R_{\text{thJS real}}$	typ.	4.1 K / W
		max.	4.9 K / W
Electrical thermal resistance junction/solderpoint ⁶⁾ with efficiency $\eta_e = 31 \%$	$R_{\text{thJS elec.}}$	typ.	2.8 K / W
		max.	3.4 K / W

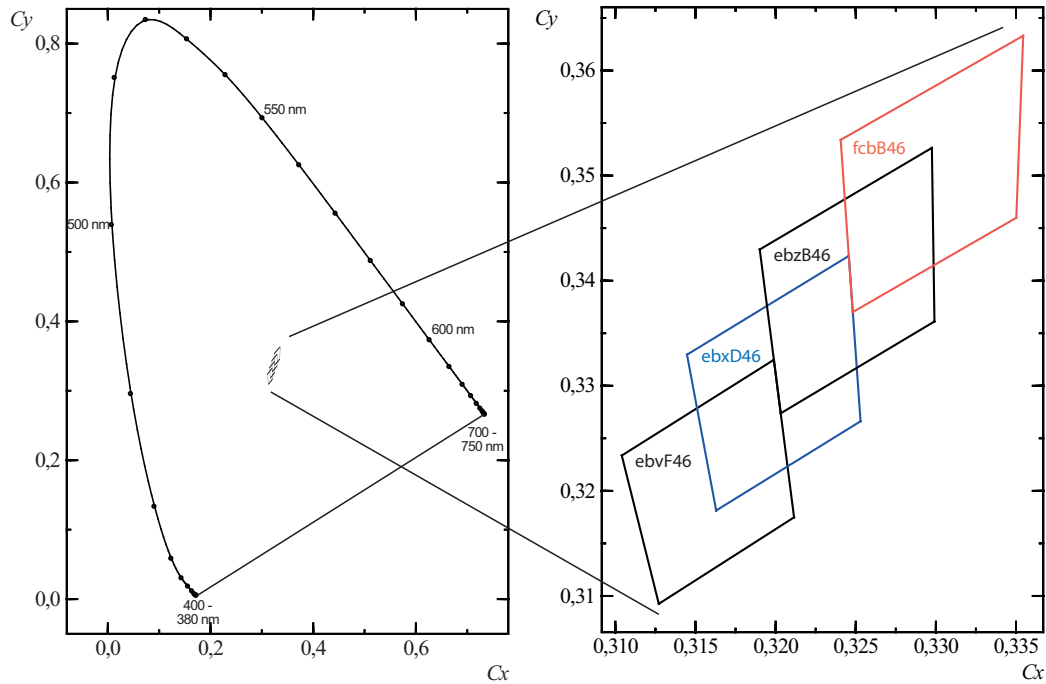
Brightness Groups

Group	Luminous Flux ¹⁾ $I_F = 1000 \text{ mA}$ min. Φ_V	Luminous Flux ¹⁾ $I_F = 1000 \text{ mA}$ max. Φ_V
5N	280 lm	315 lm
6N	315 lm	355 lm
7N	355 lm	400 lm
8N	400 lm	450 lm

Forward Voltage Groups

Group	Forward Voltage ⁵⁾ $I_F = 1000 \text{ mA}$ min. V_F	Forward Voltage ⁵⁾ $I_F = 1000 \text{ mA}$ max. V_F
15	2.75 V	3.00 V
65	3.00 V	3.25 V
B5	3.25 V	3.50 V

Chromaticity Coordinate Groups ⁴⁾



Chromaticity Coordinate Groups ⁴⁾

Group	Cx	Cy	Group	Cx	Cy
ebvF46	0.3127	0.3093	ezbB46	0.3203	0.3274
	0.3212	0.3175		0.3299	0.3361
	0.3199	0.3325		0.3298	0.3526
	0.3104	0.3234		0.3190	0.3430
ebxD46	0.3163	0.3181	fcbB46	0.3248	0.3370
	0.3253	0.3266		0.3350	0.3460
	0.3246	0.3424		0.3355	0.3633
	0.3145	0.3330		0.3241	0.3534

Group Name on Label

Example: 5N-ebvF46-15

Brightness

Color Chromaticity

Forward Voltage

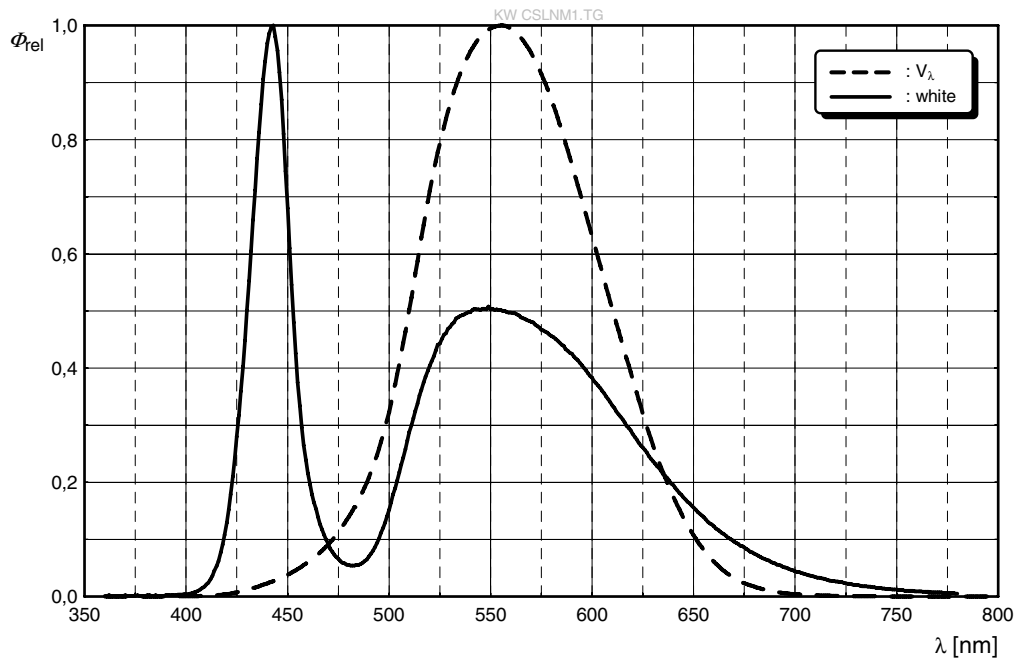
5N

ebvF46

15

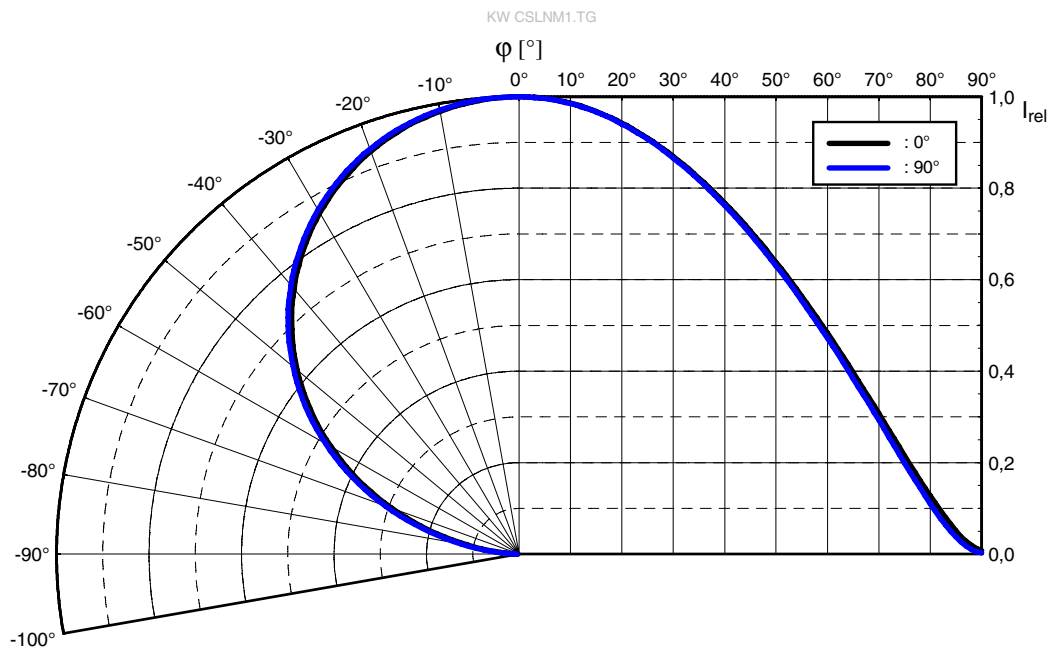
Relative Spectral Emission ³⁾

$\Phi_{rel} = f(\lambda); I_F = 1000 \text{ mA}; T_J = 25 \text{ }^\circ\text{C}$



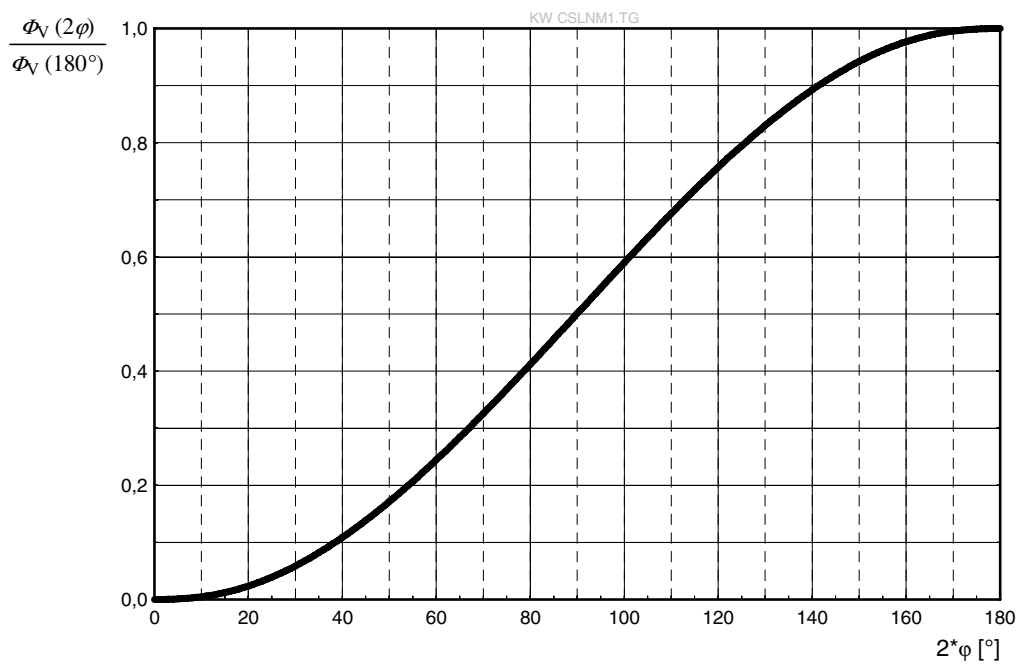
Radiation Characteristics ³⁾

$I_{rel} = f(\phi); T_J = 25 \text{ }^\circ\text{C}$



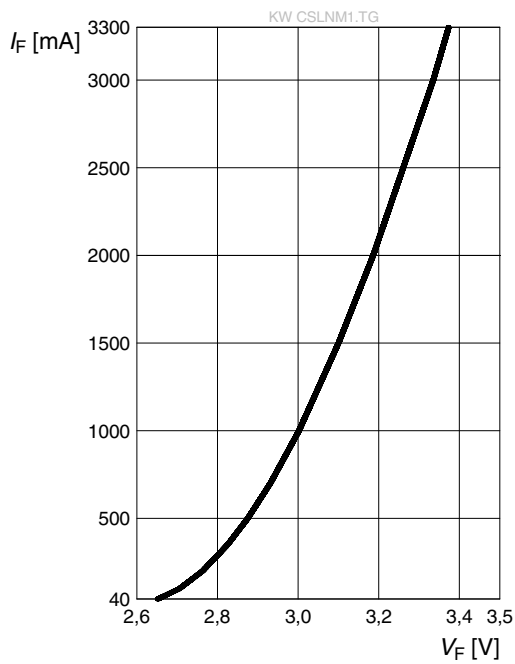
Relative Partial Flux ³⁾

$$\Phi_V(2\varphi)/\Phi_V(180^\circ) = f(\varphi); T_J = 25^\circ\text{C}$$



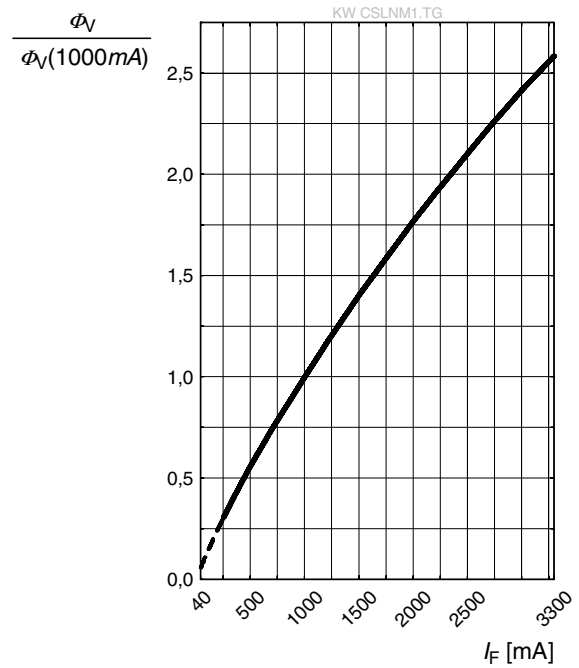
Forward current ^{3), 7)}

$$I_F = f(V_F); T_J = 25\text{ °C}$$



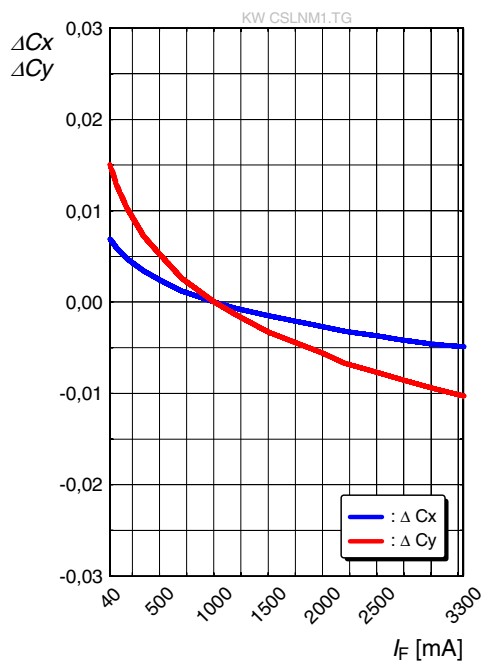
Relative Luminous Flux ^{3), 7)}

$$\Phi_V / \Phi_V(1000\text{ mA}) = f(I_F); T_J = 25\text{ °C}$$



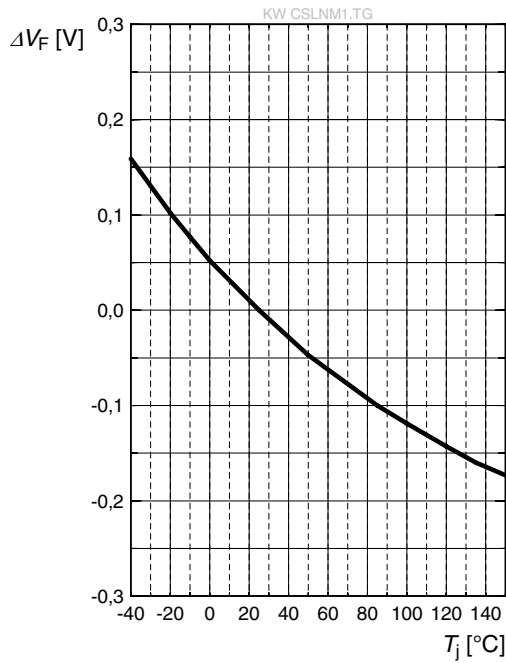
Chromaticity Coordinate Shift ³⁾

$$\Delta C_x, \Delta C_y = f(I_F); T_J = 25\text{ °C}$$



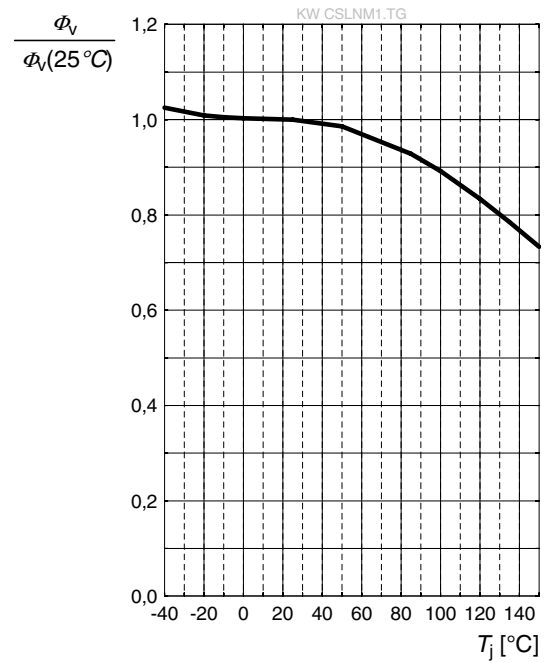
Forward Voltage ³⁾

$$\Delta V_F = V_F - V_F(25\text{ }^\circ\text{C}) = f(T_j); I_F = 1000\text{ mA}$$



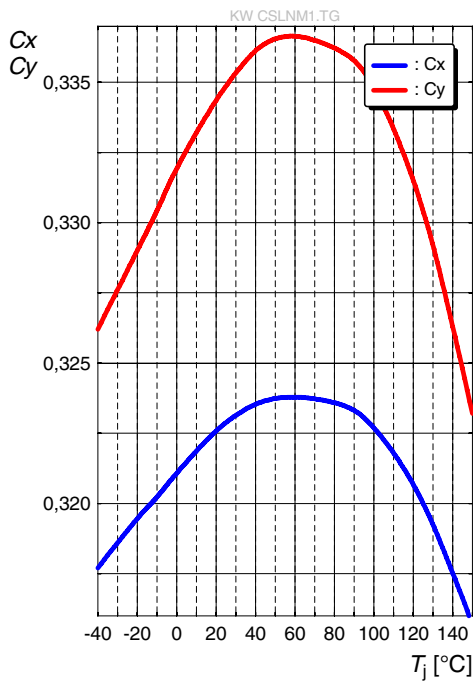
Relative Luminous Flux ³⁾

$$\Phi_V / \Phi_V(25\text{ }^\circ\text{C}) = f(T_j); I_F = 1000\text{ mA}$$



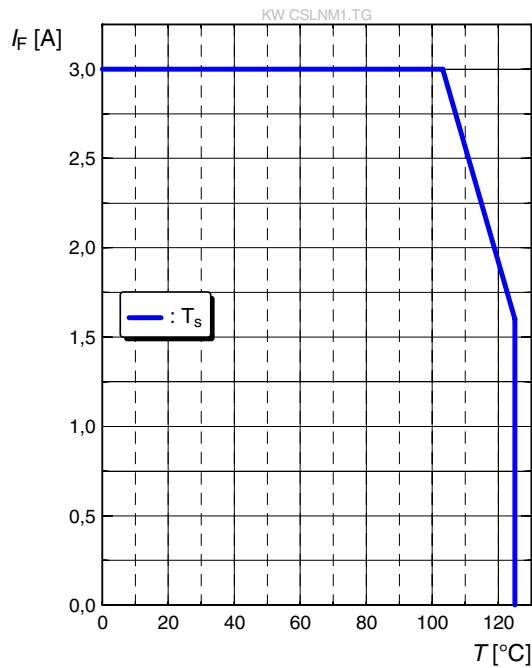
Chromaticity Coordinate Shift ³⁾

$$\Delta C_x, \Delta C_y = f(T_j); I_F = 1000\text{ mA}$$



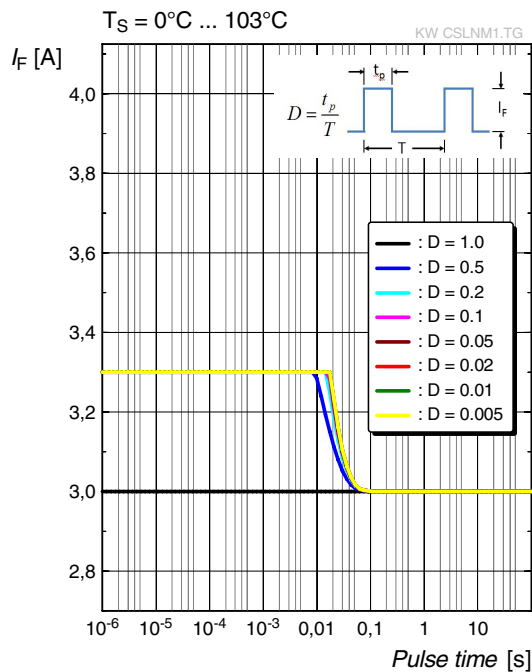
Max. Permissible Forward Current

$$I_F = f(T)$$



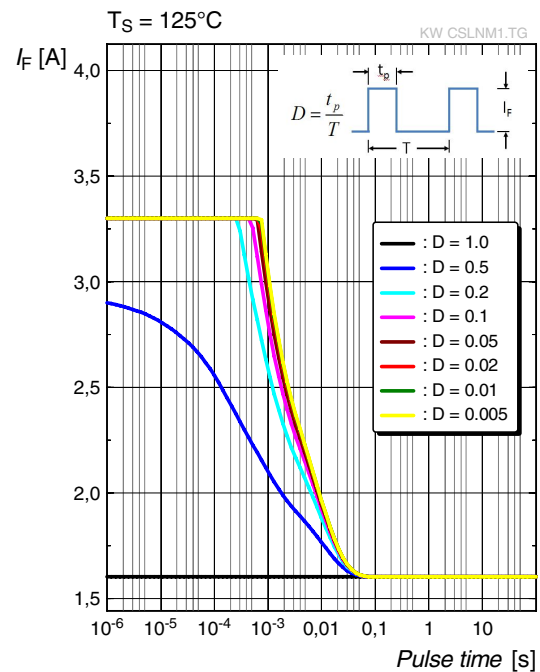
Permissible Pulse Handling Capability

$$I_F = f(t_p); D: \text{Duty cycle}$$



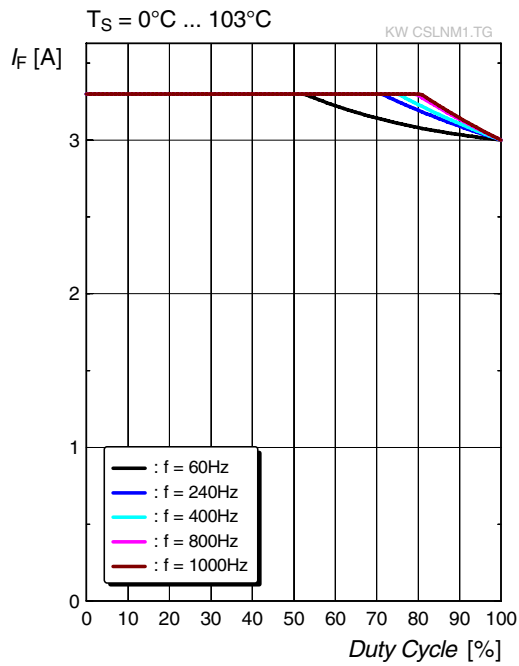
Permissible Pulse Handling Capability

$$I_F = f(t_p); D: \text{Duty cycle}$$



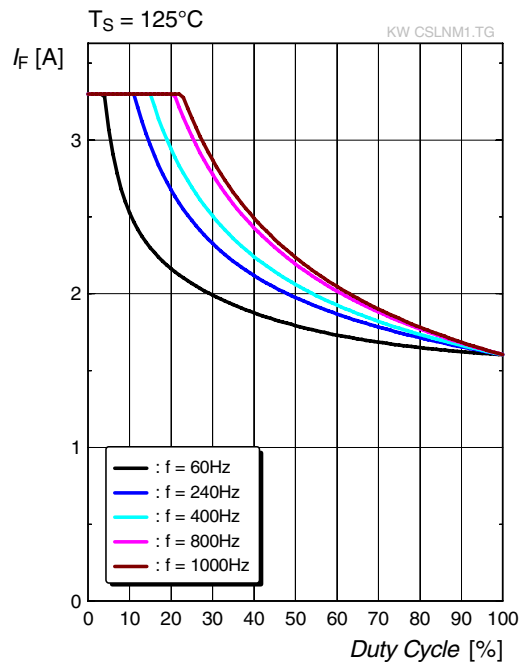
Permissible Pulse Handling Capability

f: Frequency

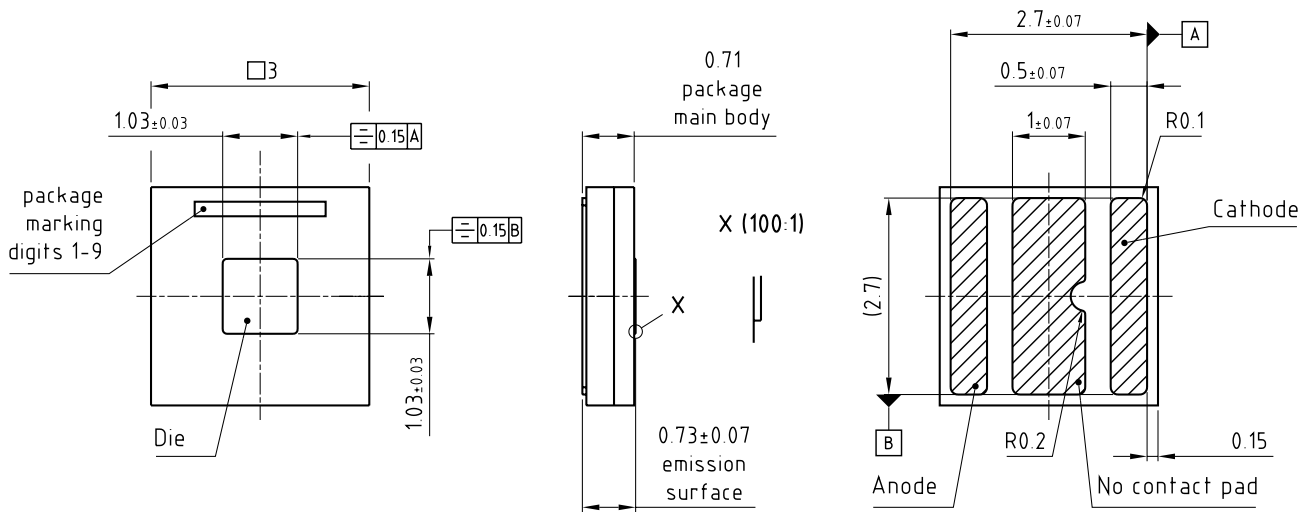


Permissible Pulse Handling Capability

f: Frequency



Dimensional Drawing ⁸⁾



general tolerance ± 0.1
 lead finish Au

C63062-A4312-A1 -04

Further Information:

Approximate Weight: 34.0 mg

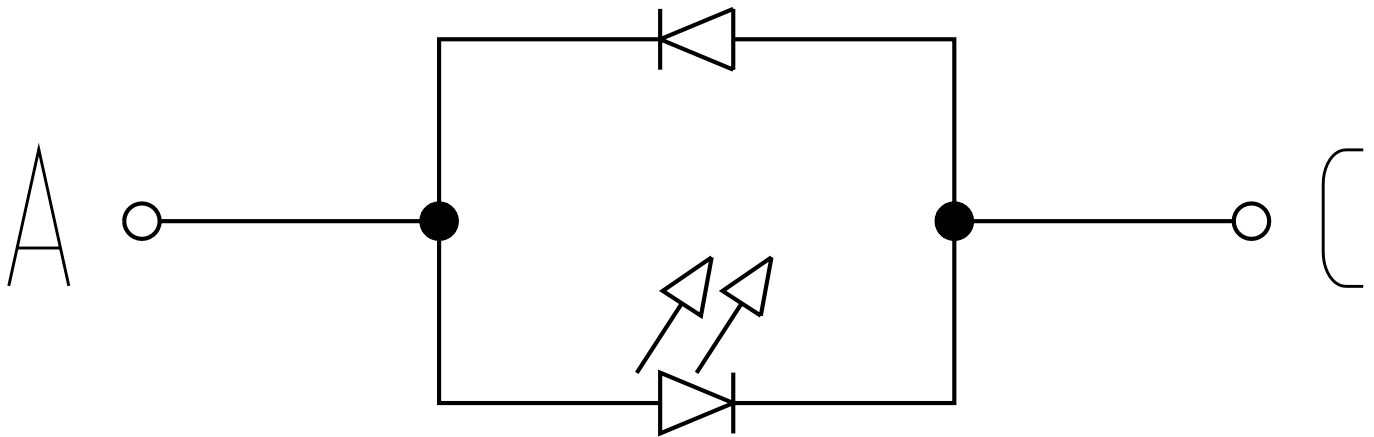
Package marking: Cathode

Corrosion test: Class: 3A
 Test condition: 40°C / 90 % RH / 15 ppm H_2S / 14 days (stricter than IEC 60068-2-43)

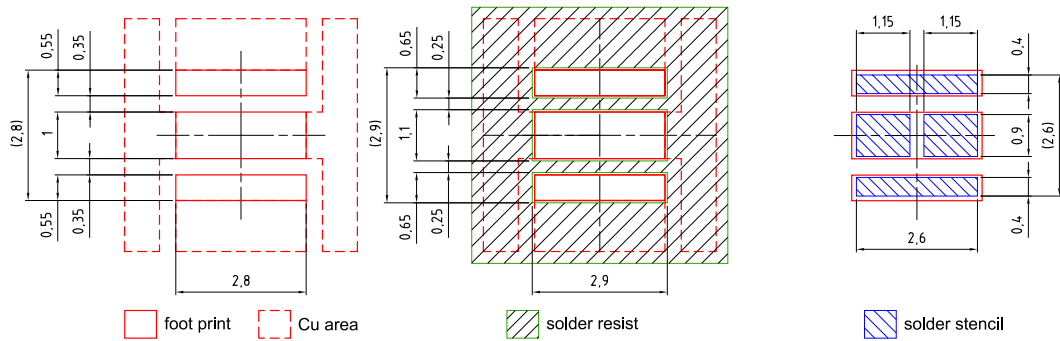
ESD advice: The device is protected by ESD device which is connected in parallel to the Chip.

Electrical Internal Circuit

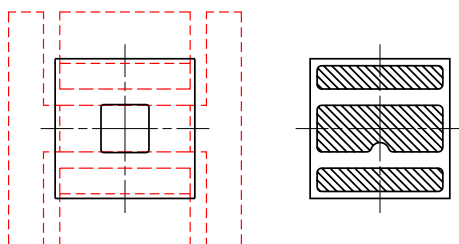
ESD Protection



Recommended Solder Pad ⁸⁾



Component Location on Pad

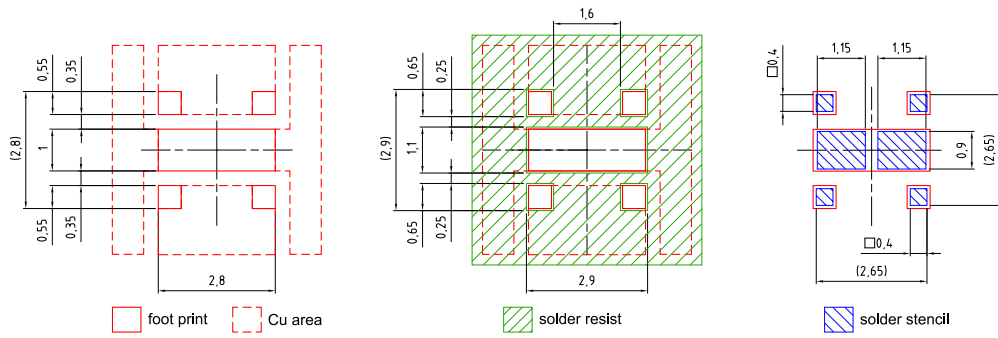


board material selection has high impact on system reliability

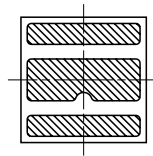
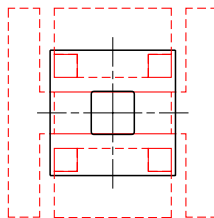
E062.3010.208 -02

Recommended Solder Pad 8)

Alternative Solder pad design for pedestal MCPCB



Component Location on Pad



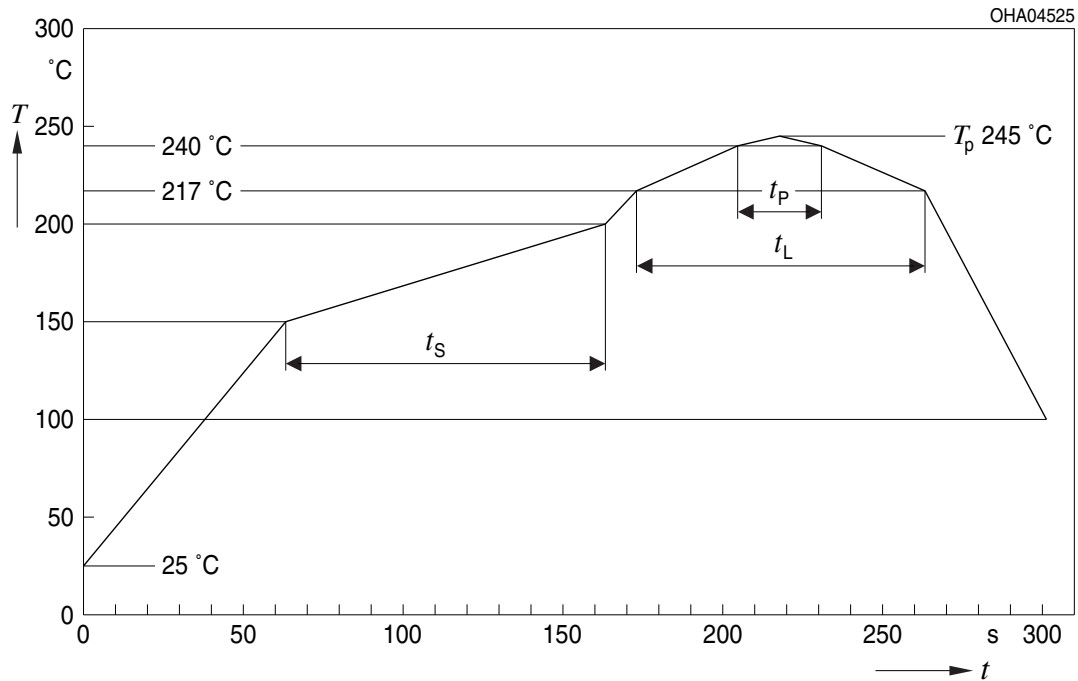
board material selection has high impact on system reliability

E062.3010.237-01

Board selection has high impact on system reliability. Package not suitable for any kind of wet cleaning or ultrasonic cleaning.

Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

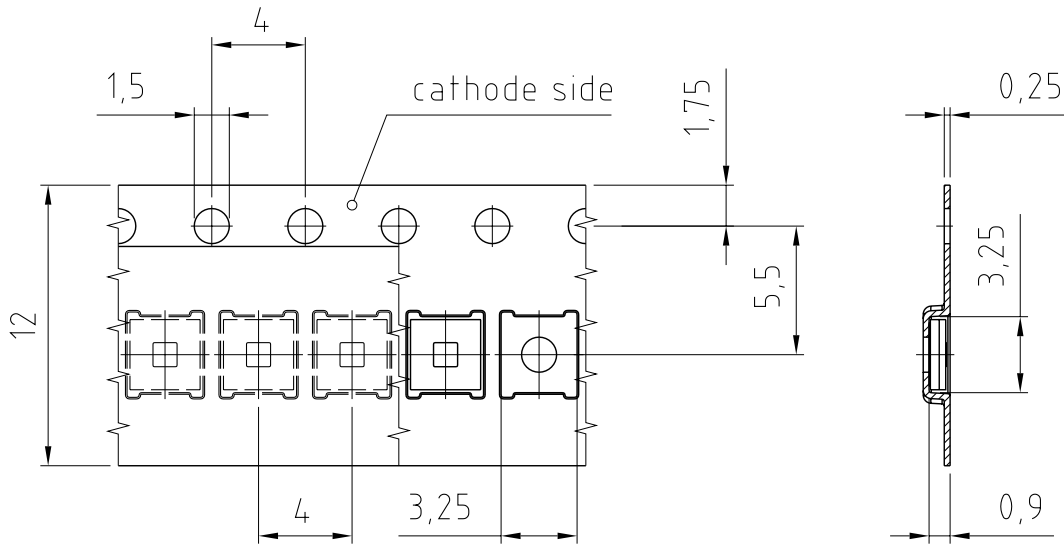


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat ^{*)} 25 °C to 150 °C			2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t_s	60	100	120	s
Ramp-up rate to peak ^{*)} T_{Smax} to T_p			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_p		245	260	°C
Time within 5 °C of the specified peak temperature $T_p - 5$ K	t_p	10	20	30	s
Ramp-down rate* T_p to 100 °C			3	6	K/s
Time 25 °C to T_p				480	s

All temperatures refer to the center of the package, measured on the top of the component

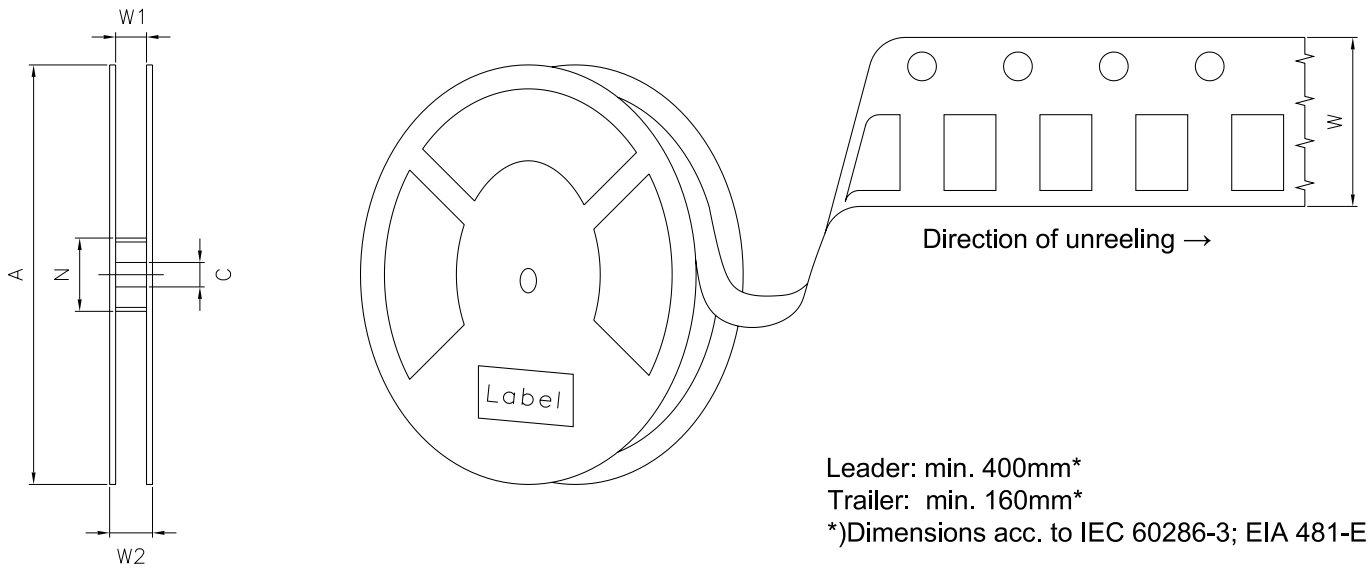
* slope calculation DT/Dt : Dt max. 5 s; fulfillment for the whole T-range

Taping ⁸⁾



C63062-A4312-B3-03

Tape and Reel ⁹⁾



Reel Dimensions

A	W	N_{min}	W_1	W_{2max}	Pieces per PU
180 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	1000

Barcode-Product-Label (BPL)

OSRAM Opto Semiconductors LX XXXX BIN1: XX-XX-X-XXX-X

RoHS Compliant

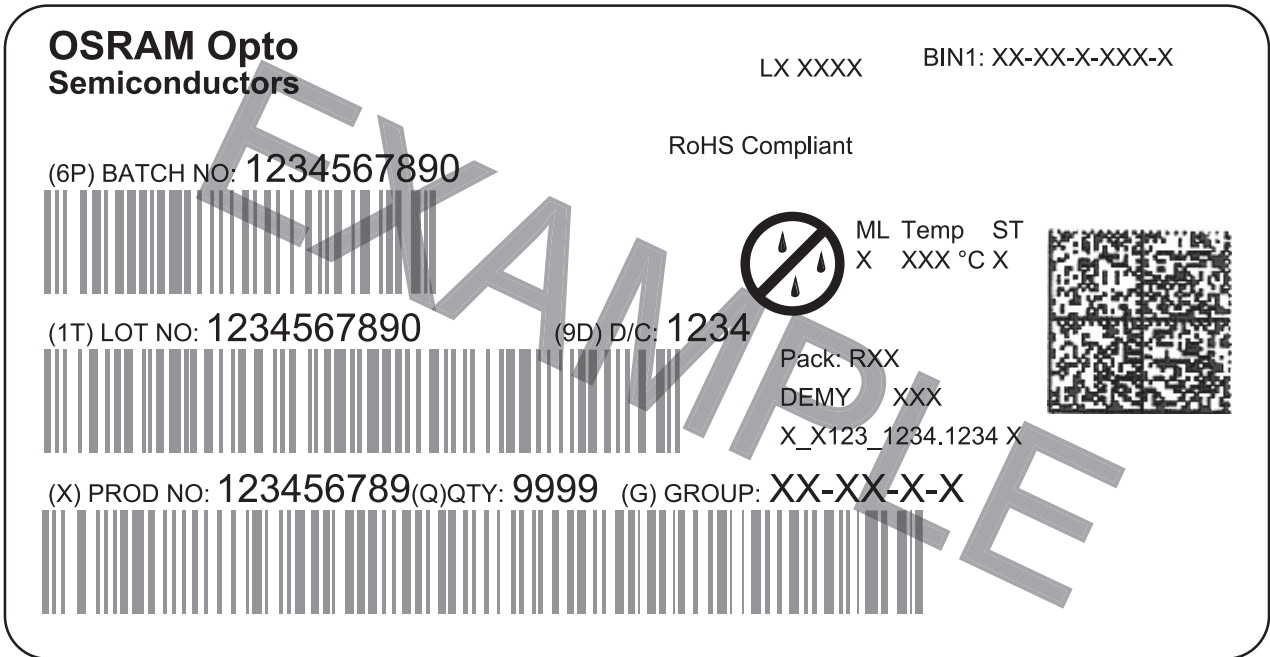
(6P) BATCH NO: 1234567890

(1T) LOT NO: 1234567890 (9D) D/C: 1234

(X) PROD NO: 123456789(Q)QTY: 9999 (G) GROUP: XX-XX-X-X

ML Temp ST
X XXX °C X

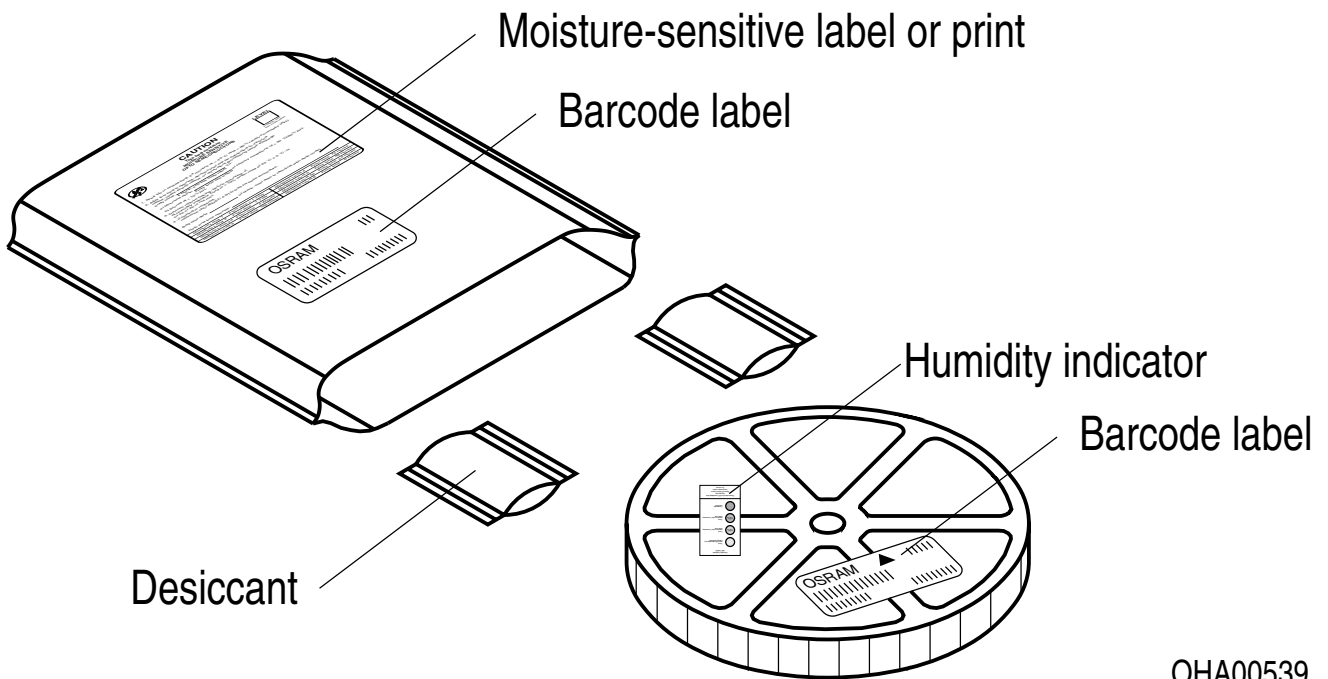
Pack: RXX
DEMY XXX
X_X123_1234.1234 X



The diagram shows a rectangular label with rounded corners. It contains the OSRAM logo and product name at the top left. To the right are fields for 'LX XXXX' and 'BIN1: XX-XX-X-XXX-X'. Below the logo is a 'RoHS Compliant' statement. The label features three horizontal barcode sections. The first is labeled '(6P) BATCH NO: 1234567890'. The second is labeled '(1T) LOT NO: 1234567890' and '(9D) D/C: 1234'. The third is labeled '(X) PROD NO: 123456789(Q)QTY: 9999' and '(G) GROUP: XX-XX-X-X'. To the right of the second barcode is a circular icon with a crossed-out rain cloud and the text 'ML Temp ST X XXX °C X'. Below this is a square QR code. At the bottom right of the label area, there is a vertical text string: 'Pack: RXX', 'DEMY XXX', and 'X_X123_1234.1234 X'. A large, semi-transparent watermark 'EXAMPLE' is overlaid diagonally across the entire label area.

OHA04563

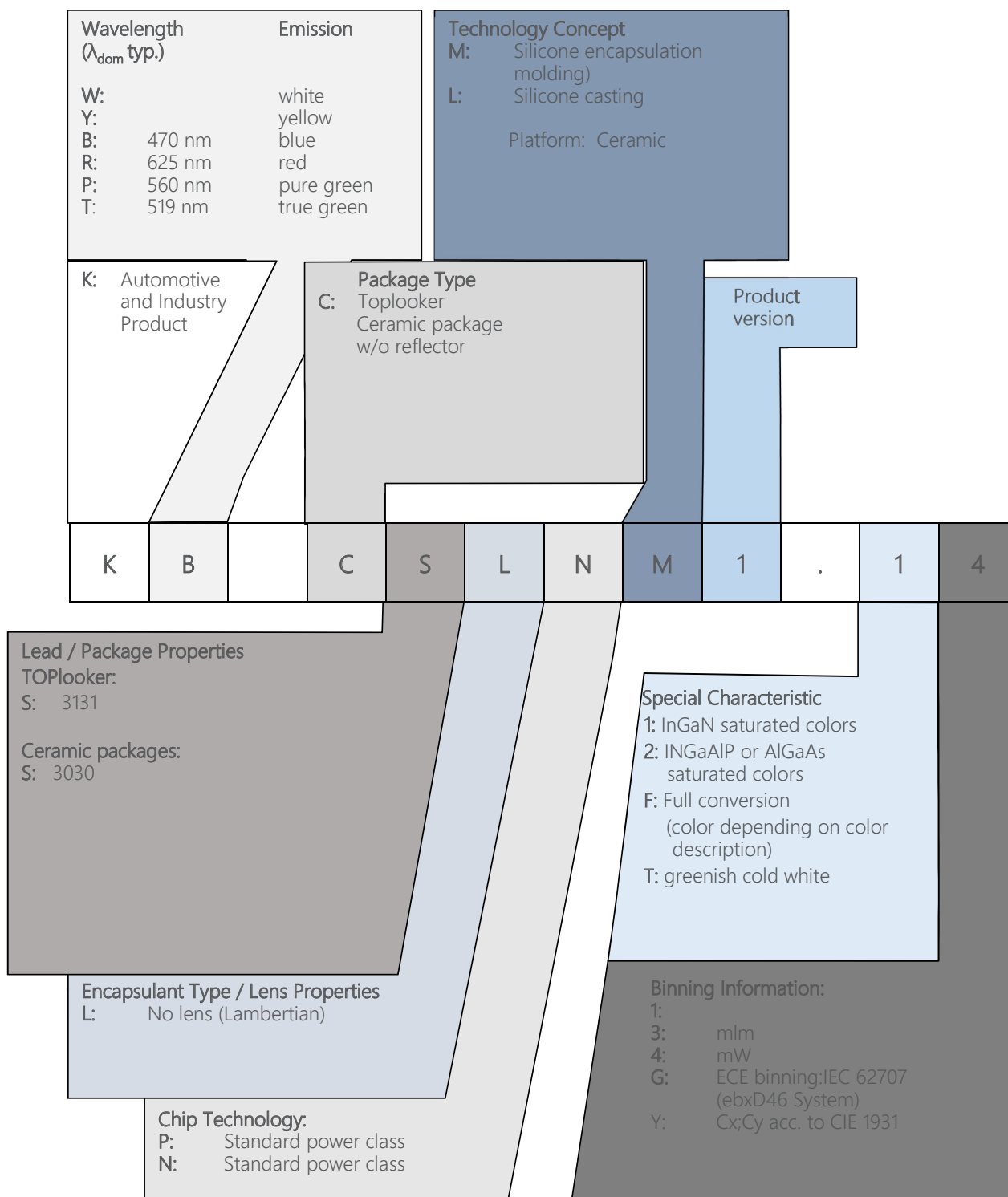
Dry Packing Process and Materials ⁸⁾



OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Type Designation System



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **moderate risk (exposure time 0.25 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers avoid device exposure to aggressive substances during storage, production, and use.

For further application related information please visit www.osram-os.com/appnotes

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.

Glossary

- 1) **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (acc. to GUM with a coverage factor of $k = 3$).
- 2) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- 3) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 4) **Chromaticity coordinate groups:** Chromaticity coordinates are measured during a current pulse of typically 25 ms, with an internal reproducibility of ± 0.005 and an expanded uncertainty of ± 0.01 (acc. to GUM with a coverage factor of $k = 3$).
- 5) **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of $\pm 0.05\text{ V}$ and an expanded uncertainty of $\pm 0.1\text{ V}$ (acc. to GUM with a coverage factor of $k = 3$).
- 6) **Thermal Resistance:** $R_{th\ max}$ is based on statistic values (6σ).
- 7) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 8) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimensions are specified in mm.
- 9) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
1.3	2020-07-06	Ordering Information
1.4	2020-07-16	Features
1.4	2020-07-17	Features
1.5	2020-10-30	Maximum Ratings

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